### 502273929 03/15/2013

# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Stuart Daughtridge	03/15/2013
Robert Potter	03/14/2013

### **RECEIVING PARTY DATA**

Name:	Kratos Integral Holdings, LLC
Street Address:	4820 Eastgate Mall, Suite 200
City:	San Diego
State/Country:	CALIFORNIA
Postal Code:	92121

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13843393

# **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 119085-011UTL

NAME OF SUBMITTER: Jennifer K. Mundee

Total Attachments: 1

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PATENT REEL: 030023 FRAME: 0245 138/33

CH \$40,00

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## ASSIGNMENT

WHEREAS, I, as a below named inventor, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in ENVELOPE FEEDBACK INTERFERENCE REDUCTION AND DATA THROUGHPUT MAXIMIZATION for which application for Letters Patent of the United States of America was executed by me on the date indicated below my name:

AND WHEREAS, Kratos Integral Holdings, LLC, a Maryland limited liability company, with offices at 4820 Eastgate Mall, Suite 200, San Diego, CA 92121 (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefore in the United States and in any and all foreign countries;

NOW THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, their successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or their designee(s), as ASSIGNEE or their successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at their own expense;

And I further agree that ASSIGNEE will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the execution date, serial number and filing date capplication in the space that follow when known: Application Number:, Filing Date:	of this
This assignment executed on the dates indicated below.	
Stuart Daughtridge Name of first inventor	

Residence of first inventor

| The Chapter of Signature of first inventor | Date of Assignment |

Signature of first inventor Date of Assignment

Robert Potter
Name of second inventor

Huntingtown, MD

Residence of second inventor

Date of Assignment

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**RECORDED: 03/15/2013** 

Signature of second inventor